

BR4407**P-Channel Power MOSFET****描述 / Descriptions**

SOP-8 塑封封装 P 沟道 MOS 场效应管。

P-Channel Enhancement Mode Field Effect Transistor in a SOP-8 Plastic Package.

特征 / Features

V_{DS} (V) = -30V

I_D = -12 A (V_{GS} = -20V)

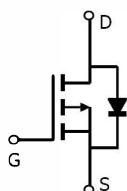
$R_{DS(ON)}$ < 13mΩ (V_{GS} = -20V)

$R_{DS(ON)}$ < 14mΩ (V_{GS} = -10V)

用途 / Applications

用于电源管理，便携式设备和电池供电系统。

Power Management in Notebook computer, Portable Equipment and Battery powered systems.

内部等效电路 / Equivalent Circuit**引脚排列 / Pinning**

PIN1 : S PIN 2 : S PIN 3 : S PIN 4 : G

PIN 5 : D PIN 6 : D PIN 7 : D PIN 8 : D

印章代码 / Marking

见印章说明 See Marking Instructions.

P-Channel Power MOSFET**极限参数 / Absolute Maximum Ratings(Ta=25°C)**

| 参数 Parameter | 符号 Symbol | 数值 Rating | 单位 Unit |
|---|--|--------------|------------|
| Drain-Source Voltage | V _{DSS} | -30 | V |
| Gate-Source Voltage | V _{GSS} | ±20 | V |
| Continuous Drain Current ^A | I _D (T _a =25°C) | -12 | A |
| Continuous Drain Current ^A | I _D (T _a =70°C) | -10 | A |
| Pulsed Drain Current ^B | I _{DM} | -60 | A |
| Power Dissipation for Single Operation ^A | P _D (T _a =25°C) | 3 | W |
| Power Dissipation for Single Operation ^A | P _D (T _a =100°C) | 2.1 | W |
| Maximum Junction Temperature | T _j | 150 | °C |
| Storage Temperature Range | T _{stg} | -55 ~ 150 | °C |
| Thermal Resistance-Junction to Ambient ^A | R _{θJA} (t≤10s) | 40 | °C/W |
| Thermal Resistance-Junction to Ambient ^A | R _{θJA} | 75 | °C/W |
| Maximum Junction-to-Lead ^C | R _{θJL} | 30 | °C/W |

Note:

A: The value of R_{θJA} is measured with the device mounted on 1in² FR-4 board with 2oz. Copper, in a still air environment with T_A = 25°C. The value in any given application depends on the user's specific board design. The current rating is based on the t ≤ 10s thermal resistance rating.

B: Repetitive rating, pulse width limited by junction temperature.

C. The R_{θJA} is the sum of the thermal impedance from junction to lead R_{θJL} and lead to ambient.

D. The static characteristics in Figures 1 to 6,12,14 are obtained using 80 μs pulses, duty cycle 0.5% max.

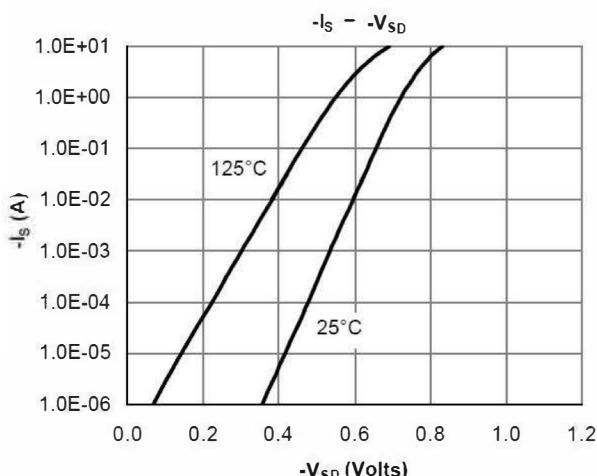
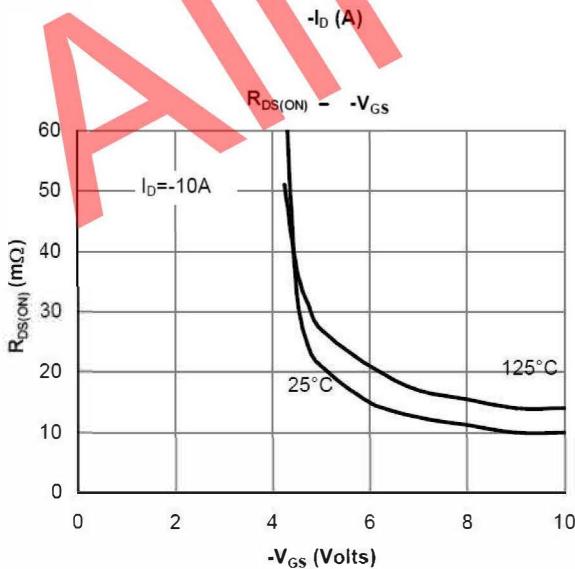
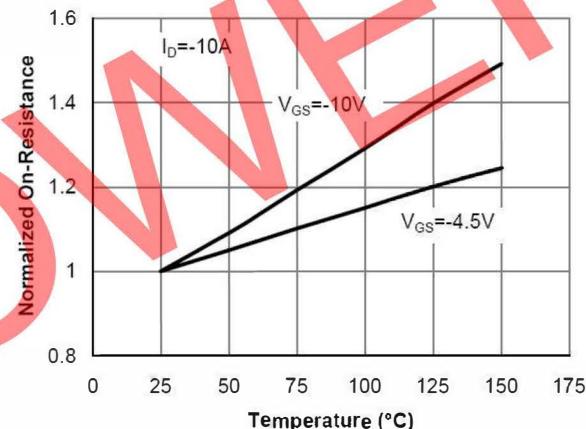
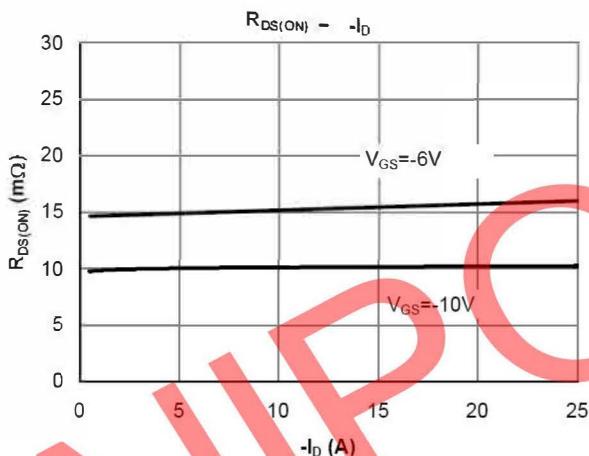
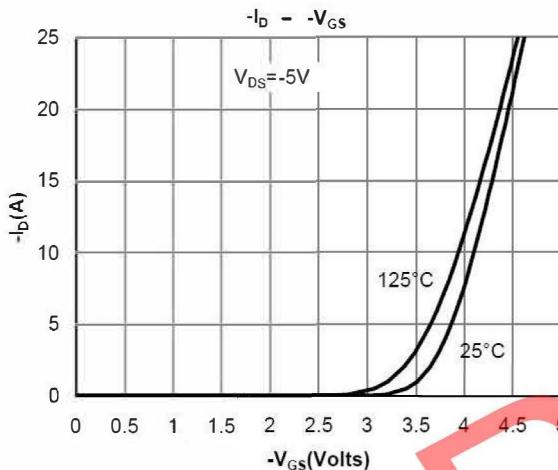
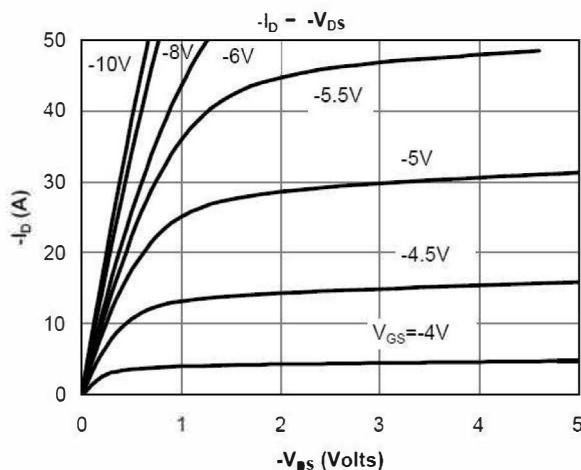
E. These tests are performed with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with T_A=25°C. The SOA curve provides a single pulse rating. Rev 1 : Sept 2005

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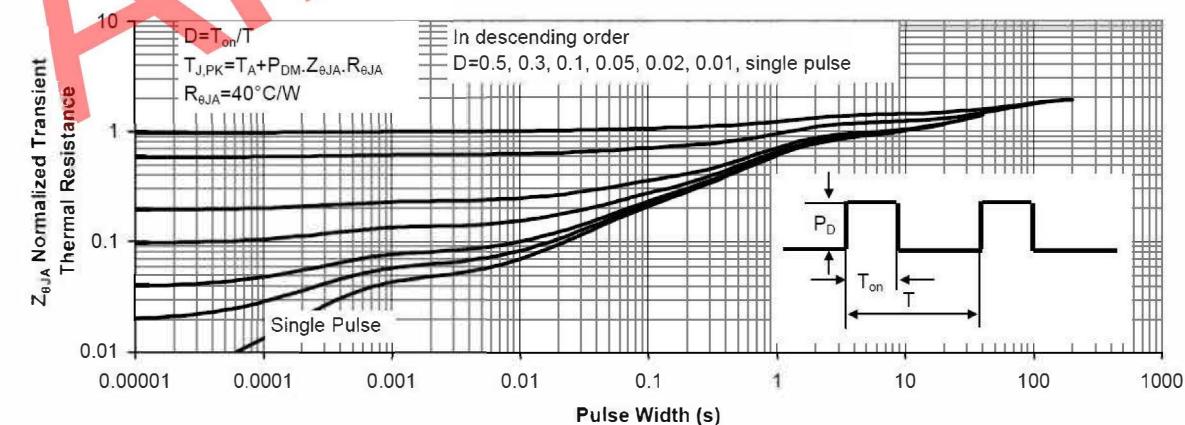
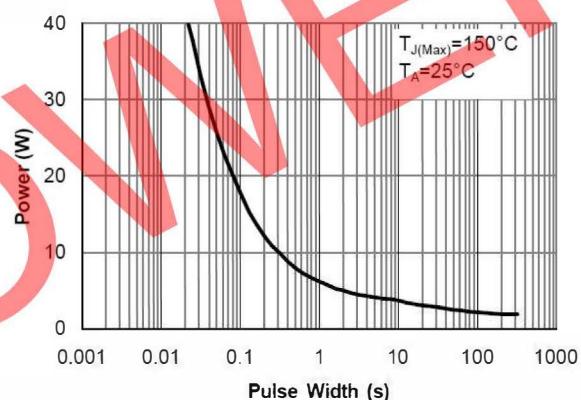
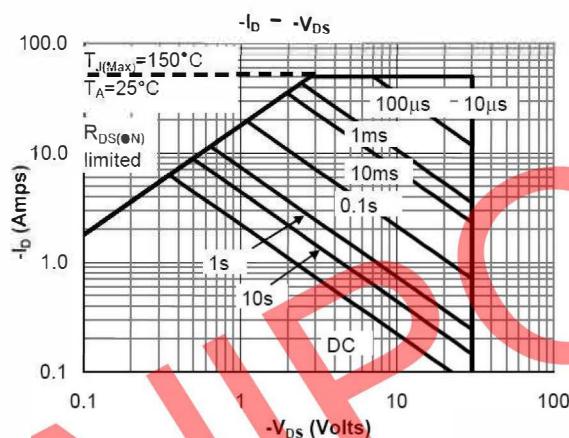
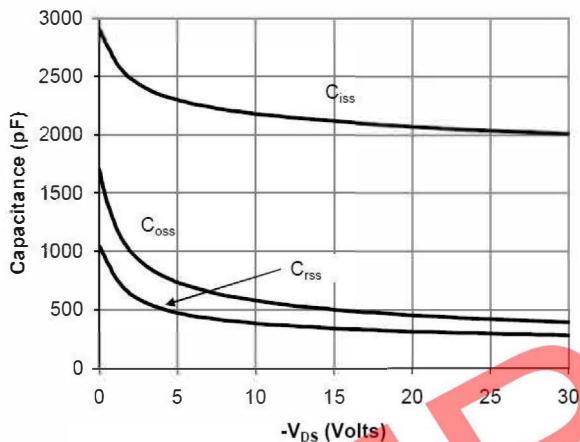
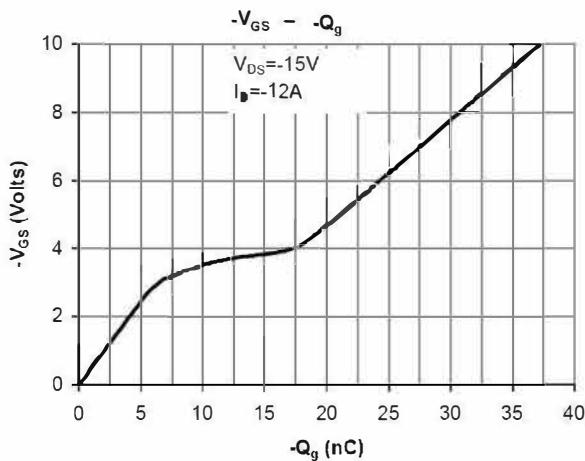
电性能参数 / Electrical Characteristics($T_a=25^\circ C$)

| 参数 Parameter | 符号 Symbol | 测试条件 Test Conditions | 最小值 Min | 典型值 Typ | 最大值 Max | 单位 Unit |
|---------------------------------------|--------------|---|------------|------------|------------|------------|
| Drain-Source Breakdown Voltage | BV_{DSS} | $I_D=-250\mu A$ $V_{GS}=0V$ | -30 | | | V |
| Zero Gate Voltage Drain Current | I_{DSS} | $V_{DS}=-24V$ $V_{GS}=0V$ | | | -1.0 | μA |
| | | $V_{DS}=-24V$ $V_{GS}=0V$ $T_J=55^\circ C$ | | | -5.0 | |
| Gate-Body leakage current | I_{GSS} | $V_{DS}=0V$ $V_{GS}=\pm 20V$ | | | ± 100 | nA |
| Gate Threshold Voltage | $V_{GS(th)}$ | $V_{DS}=V_{GS}$ $I_D=-250\mu A$ | -1.0 | -1.5 | -3.0 | V |
| On state drain current | $I_{D(ON)}$ | $V_{GS}=-10V$ $V_{DS}=-5V$ | 60 | | | A |
| Static Drain-Source On-Resistance | $R_{DS(ON)}$ | $V_{GS}=-10V$ $I_D=-10A$ | | 10 | 14 | $m\Omega$ |
| | | $V_{GS}=-10V$ $I_D=-10A$ $T_J=125^\circ C$ | | 13 | 19 | |
| | | $V_{GS}=-20V$ $I_D=-10A$ | | 9.5 | 13 | |
| | | $V_{GS}=-4.5V$ $I_D=-10A$ | | 22 | | |
| Forward Transconductance | g_{FS} | $V_{DS}=-5V$ $I_D=-10A$ | | 26 | | S |
| Diode Forward Voltage | V_{SD} | $I_S=-1A$ $V_{GS}=0V$ | | -0.72 | -1.0 | V |
| Maximum Body-Diode Continuous Current | | | | | -4.2 | A |
| Total Gate Charge | Q_g | | | 37.2 | 45 | nC |
| Gate-Source Charge | Q_{gs} | $V_{GS}=-10V$ $V_{DS}=-15V$ $I_D=-12A$ | | 7 | | |
| Gate-Drain Charge | Q_{gd} | | | 10.4 | | |
| Gate Resistance | R_g | $V_{GS}=0V$ $V_{DS}=0V$ $f=1MHz$ | | 2.0 | 3.0 | Ω |
| Input Capacitance | C_{iss} | $V_{GS}=0V$ $V_{DS}=-15V$ $f=1MHz$ | | 2076 | 2500 | pF |
| Output Capacitance | C_{oss} | | | 503 | | |
| Reverse Transfer Capacitance | C_{rss} | | | 302 | | |
| Turn-on Delay Time | $t_{d(ON)}$ | $V_{GS}=-10V$ $V_{DS}=-15V$ $R_L=1.25\Omega$ $R_{GEN}=3\Omega$ | | 12.4 | | ns |
| Turn-on Rise Time | t_r | | | 8.2 | | |
| Turn-off Delay Time | $t_{d(OFF)}$ | | | 25.6 | | |
| Turn-off Fall Time | t_f | | | 12 | | |
| Body Diode Reverse Recovery Time | t_{rr} | $I_F=-12A$ $di/dt=100A/\mu s$ | | 33 | 40 | ns |
| Body Diode Reverse Recovery Charge | Q_{rr} | $I_F=-12A$ $di/dt=100A/\mu s$ | | 23 | | nC |

P-Channel Power MOSFET**电参数曲线图 / Electrical Characteristic Curve**

P-Channel Power MOSFET

电参数曲线图 / Electrical Characteristic Curve



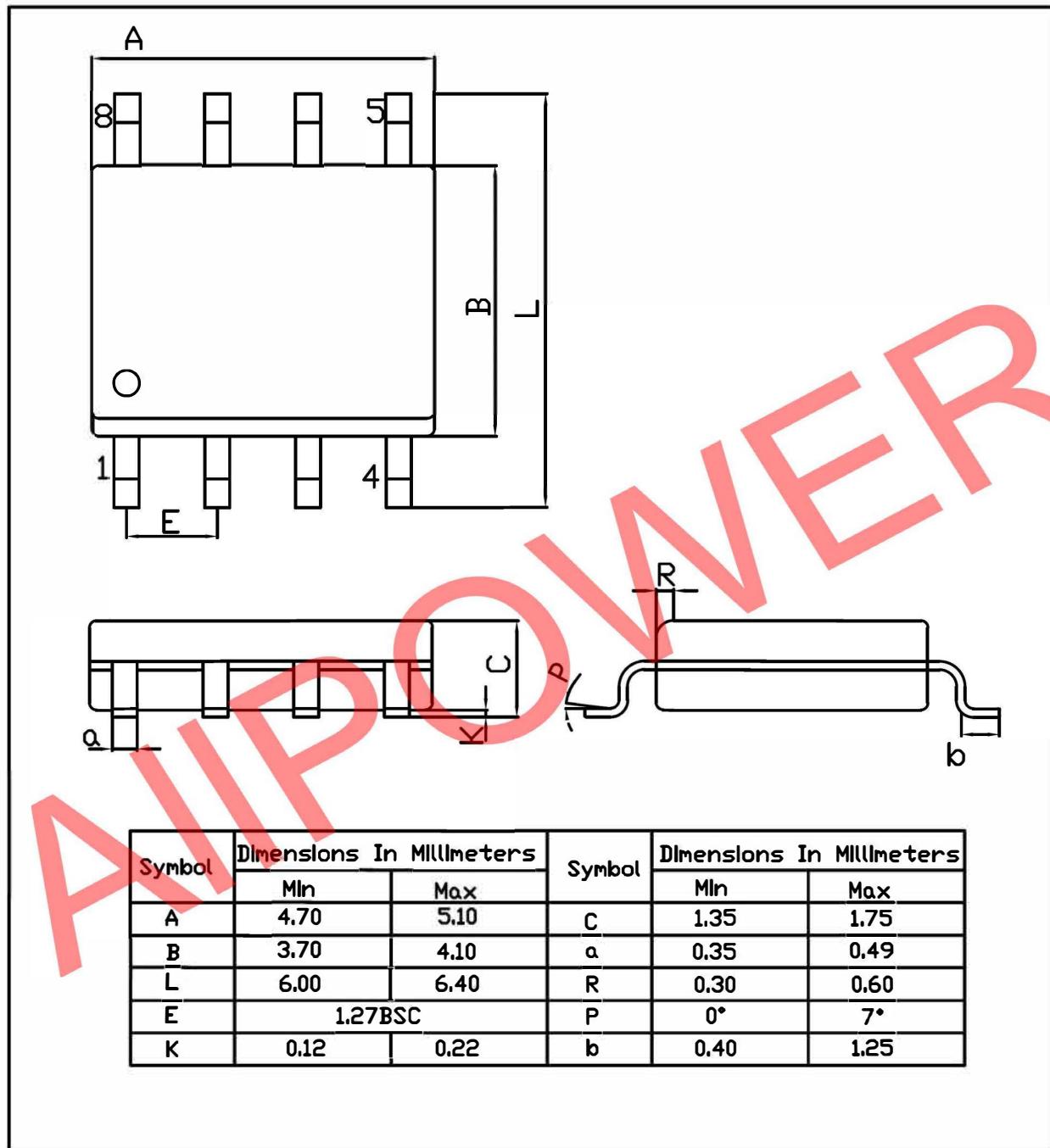
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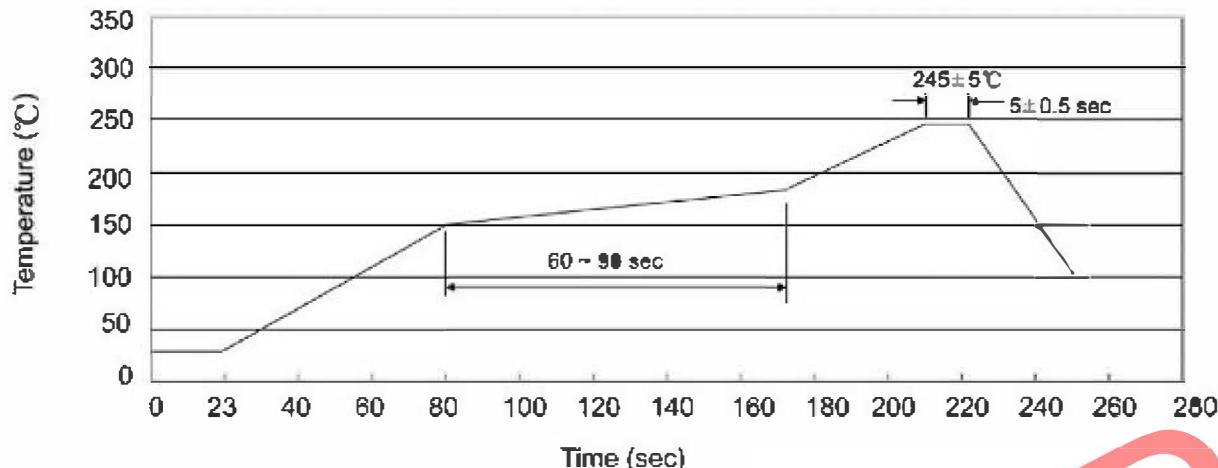
P-Channel Power MOSFET

外形尺寸图 / Package Dimensions

SOP-8

Unit:mm



P-Channel Power MOSFET**回流焊温度曲线图(无铅) / Temperature Profile for IR Reflow Soldering(Pb-Free)****说明 :**

- 1、预热温度 25 ~ 150°C , 时间 60 ~ 90sec;
- 2、峰值温度 245±5°C , 时间持续为 5±0.5sec;
- 3、焊接制程冷却速度为 2 ~ 10°C/sec.

Note:

- 1.Preheating:25~150°C, Time:60~90sec.
- 2.Peak Temp.:245±5°C, Duration:5±0.5sec.
- 3.Cooling Speed: 2~10°C/sec.

耐焊接热试验条件 / Resistance to Soldering Heat Test Conditions

温度 : 260±5°C

时间 : 10±1 sec.

Temp.:260±5°C

Time:10±1 sec

包装规格 / Packaging SPEC.**卷盘包装 / REEL**

| Package Type 封装形式 | Units 包装数量 | | | | | Dimension 包装尺寸 (unit: mm ³) | | |
|----------------------|--------------------|-------------------------|------------------------|------------------------------|------------------------|---|-------------|-------------|
| | Units/Reel 只/卷盘 | Reels/Inner Box 卷盘/盒 | Units/Inner Box 只/盒 | Inner Boxes/Outer Box 盒/箱 | Units/Outer Box 只/箱 | Reel | Inner Box 盒 | Outer Box 箱 |
| SOP/ESOP-8 | 4,000 | 2 | 8,000 | 5 | 40,000 | 13" ×16 | 360×360×50 | 385×257×392 |

使用说明 / Notices

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